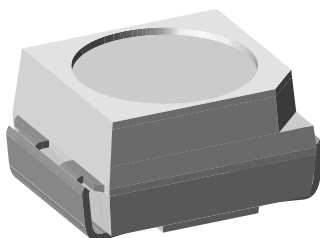


## Low Current SMD LED PLCC-2



19225

### DESCRIPTION

These new devices have been designed to meet the increasing demand for low current SMD LEDs.

The package of the VLMA3100 is the PLCC-2 (equivalent to a size B tantalum capacitor).

It consists of a lead frame which is embedded in a white thermoplast. The reflector inside this package is filled up with clear epoxy.

### PRODUCT GROUP AND PACKAGE DATA

- Product group: LED
- Package: SMD PLCC-2
- Product series: low current
- Angle of half intensity:  $\pm 60^\circ$

### FEATURES

- SMD LED with exceptional brightness
- Compatible with automatic placement equipment
- EIA and ICE standard package
- Compatible with infrared, vapor phase and wave solder processes according to CECC
- Available in 8 mm tape
- Low profile package
- Non-diffused lens: Excellent for coupling to light pipes and backlighting
- Very low power consumption
- Luminous intensity ratio in one packaging unit  $I_{Vmax}/I_{Vmin} \leq 2.0$
- AEC-Q101 qualified
- Material categorization: For definitions of compliance please see [www.vishay.com/doc?99912](http://www.vishay.com/doc?99912)



### APPLICATIONS

- Automotive: Backlighting in dashboards and switches
- Telecommunication: Indicator and backlighting in telephone and fax
- Indicator and backlight for audio and video equipment
- Indicator and backlight for battery driven equipment
- Small indicator for outdoor applications
- Indicator and backlight in office equipment
- Flat backlight for LCDs, switches, and symbols
- General use

### PARTS TABLE

PART	COLOR	LUMINOUS INTENSITY (mcd)			at $I_F$ (mA)	WAVELENGTH (nm)			at $I_F$ (mA)	FORWARD VOLTAGE (V)			at $I_F$ (mA)	TECHNOLOGY
		MIN.	TYP.	MAX.		MIN.	TYP.	MAX.		MIN.	TYP.	MAX.		
VLMA3100-GS08	Yellow	0.28	2.5	-	6	581	-	594	2	-	2.2	2.9	2	GaAsP on GaP
VLMA3100-GS18	Yellow	0.28	2.5	-	6	581	-	594	2	-	2.2	2.9	2	GaAsP on GaP

### ABSOLUTE MAXIMUM RATINGS ( $T_{amb} = 25^\circ\text{C}$ , unless otherwise specified)

#### VLMA3100

PARAMETER	TEST CONDITION	SYMBOL	VALUE	UNIT
Reverse voltage <sup>(1)</sup>		$V_R$	6	V
DC forward current		$I_F$	7	mA
Surge forward current	$t_p \leq 10 \mu\text{s}$	$I_{FSM}$	0.5	A
Power dissipation		$P_V$	20	mW
Junction temperature		$T_j$	100	$^\circ\text{C}$
Operating temperature range		$T_{amb}$	-40 to +100	$^\circ\text{C}$
Storage temperature range		$T_{stg}$	-40 to +100	$^\circ\text{C}$
Soldering temperature	$t \leq 5 \text{ s}$	$T_{sd}$	260	$^\circ\text{C}$
Thermal resistance junction/ambient	Mounted on PC board (pad size $> 16 \text{ mm}^2$ )	$R_{thJA}$	500	K/W

#### Note

- <sup>(1)</sup> Driving the LED in reverse direction is suitable for short term application

**OPTICAL AND ELECTRICAL CHARACTERISTICS** ( $T_{amb} = 25\text{ }^{\circ}\text{C}$ , unless otherwise specified)  
**VLMA3100, YELLOW**

PARAMETER	TEST CONDITION	PART	SYMBOL	MIN.	TYP.	MAX.	UNIT
Luminous intensity <sup>(1)</sup>	$I_F = 2\text{ mA}$	VLMA3100	$I_V$	0.28	2.5	-	mcd
Dominant wavelength	$I_F = 2\text{ mA}$		$\lambda_d$	581	-	594	nm
Peak wavelength	$I_F = 2\text{ mA}$		$\lambda_p$	-	585	-	nm
Angle of half intensity	$I_F = 2\text{ mA}$		$\phi$	-	$\pm 60$	-	deg
Forward voltage	$I_F = 2\text{ mA}$		$V_F$	-	2.2	2.9	V
Reverse voltage	$I_R = 10\text{ }\mu\text{A}$		$V_R$	6	20	-	V
Junction capacitance	$V_R = 0\text{ V}$ , $f = 1\text{ MHz}$		$C_j$	-	50	-	pF

**Note**

<sup>(1)</sup> In one packing unit  $I_{Vmax}/I_{Vmin} \leq 2.0$

**LUMINOUS INTENSITY CLASSIFICATION**

GROUP	LUMINOUS INTENSITY (mcd)	
	MIN.	MAX.
C1	0.28	0.36
C2	0.36	0.45
D1	0.45	0.56
D2	0.56	0.71
E1	0.71	0.90

**Note**

- Luminous intensity is tested at a current pulse duration of 25 ms and an accuracy of  $\pm 11\%$ .  
The above Type Numbers represent the order groups which include only a few brightness groups. Only one group will be shipped on each reel (there will be no mixing of two groups on each reel). In order to ensure availability, single brightness groups will not be orderable.  
In a similar manner for colors where wavelength groups are measured and binned, single wavelength groups will be shipped on any one reel.  
In order to ensure availability, single wavelength groups will not be orderable.

**COLOR CLASSIFICATION**

GROUP	YELLOW	
	DOMINANT WAVELENGTH (nm)	
	MIN.	MAX.
1	581	584
2	583	586
3	585	588
4	587	590
5	589	592
6	591	594

**Note**

- Wavelengths are tested at a current pulse duration of 25 ms.

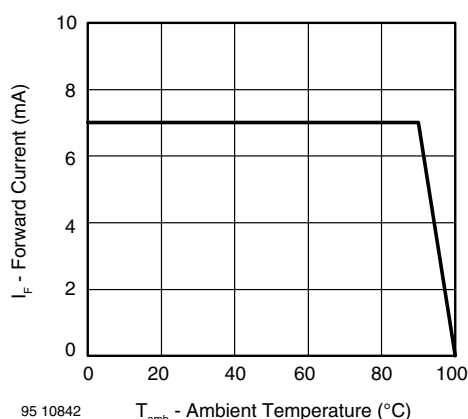
**TYPICAL CHARACTERISTICS** ( $T_{amb} = 25\text{ }^{\circ}\text{C}$ , unless otherwise specified)


Fig. 1 - Forward Current vs. Ambient Temperature

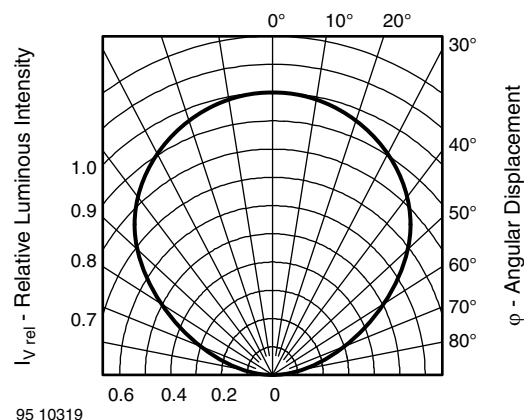


Fig. 2 - Relative Luminous Intensity vs. Angular Displacement

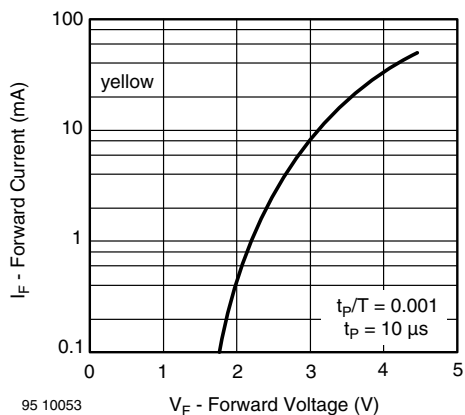


Fig. 3 - Forward Current vs. Forward Voltage

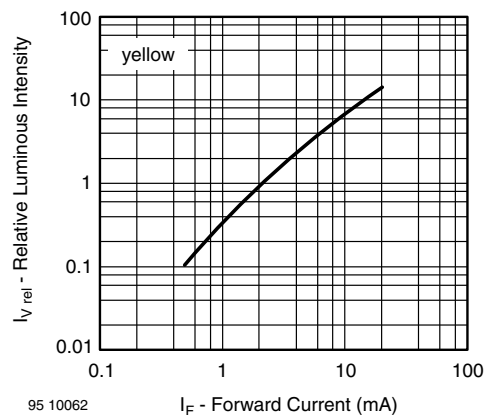


Fig. 6 - Relative Luminous Intensity vs. Forward Current

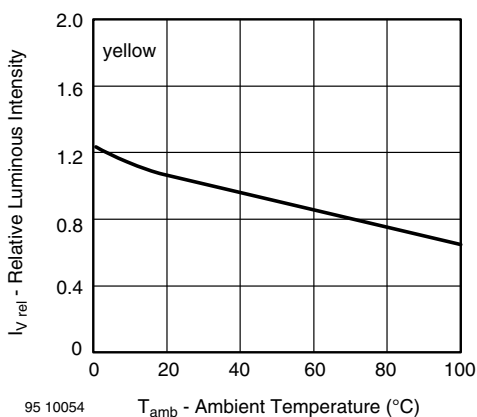


Fig. 4 - Relative Luminous Intensity vs. Ambient Temperature

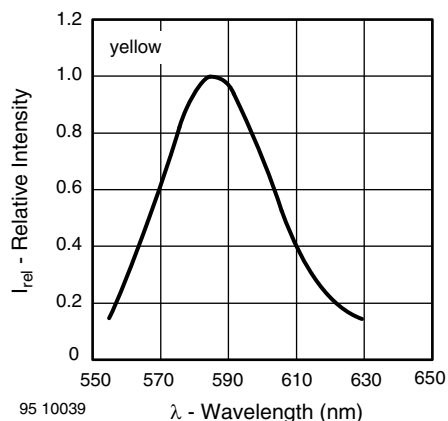


Fig. 7 - Relative Intensity vs. Wavelength

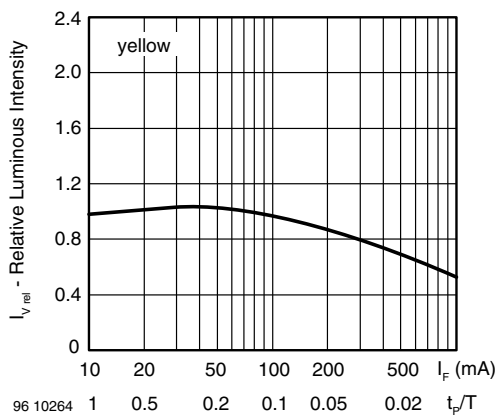
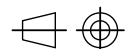
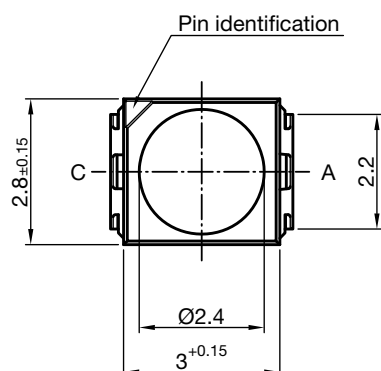
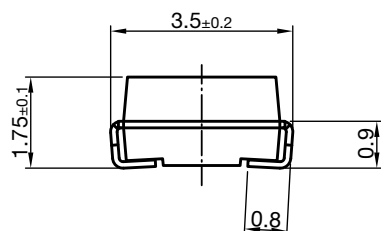


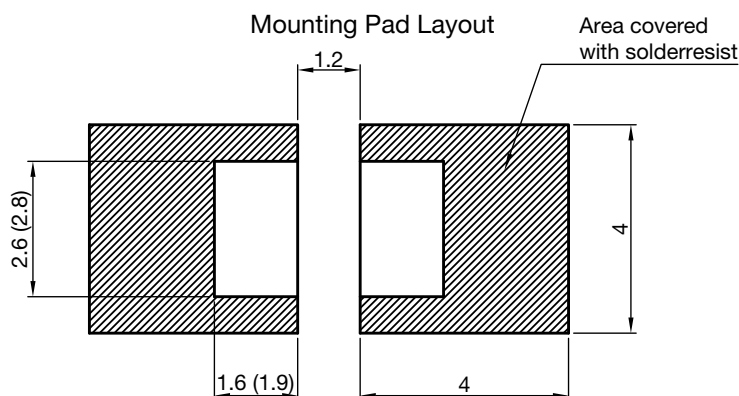
Fig. 5 - Relative Luminous Intensity vs. Forward Current/Duty Cycle

**PACKAGE DIMENSIONS** in millimeters


Technical drawings  
according to DIN  
specifications

Dimensions in mm

Drawing-No.: 6.541-5067.01-4  
Issue: 6; 23.09.13

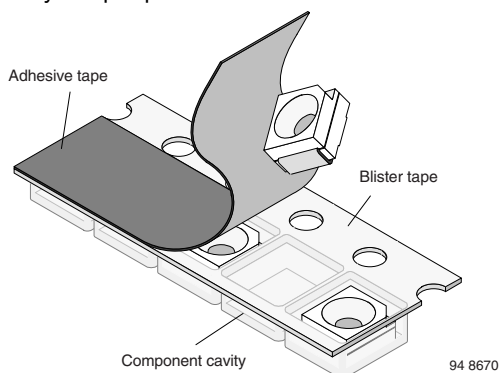


Dimensions: Reflow and vapor phase (wave soldering)

## METHOD OF TAPING/POLARITY AND TAPE AND REEL

### SMD LED (VLM.3 - SERIES)

Vishay's LEDs in SMD packages are available in an antistatic 8 mm blister tape (in accordance with DIN IEC 40 (CO) 564) for automatic component insertion. The blister tape is a plastic strip with impressed component cavities, covered by a top tape.



### EEL PACKAGE DIMENSION IN MILLIMETERS FOR SMD LEDS, TAPE OPTION GS18 (= 8000 PCS.) PREFERRED

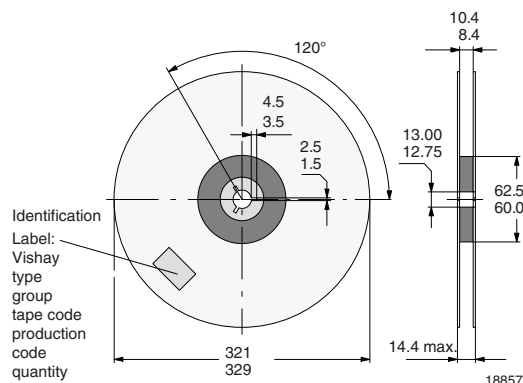


Fig. 10 - Reel dimensions - GS18

### TAPING OF VLM.3...

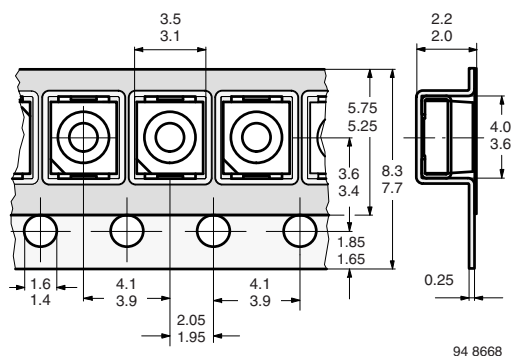


Fig. 8 - Tape dimensions in mm for PLCC-2

### REEL PACKAGE DIMENSION IN MILLIMETERS FOR SMD LEDS, TAPE OPTION GS08 (= 1500 PCS.)

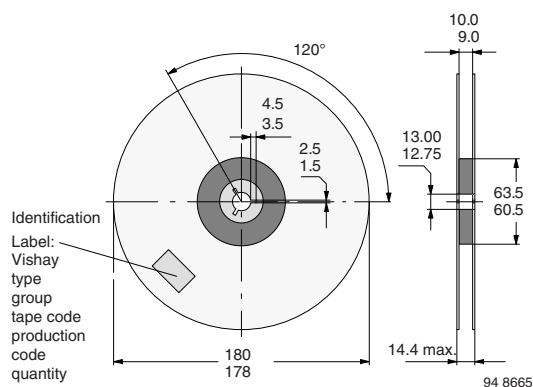


Fig. 9 - Reel dimensions - GS08

### SOLDERING PROFILE

IR Reflow Soldering Profile for Lead (Pb)-free Soldering  
Preconditioning acc. to JEDEC level 2a

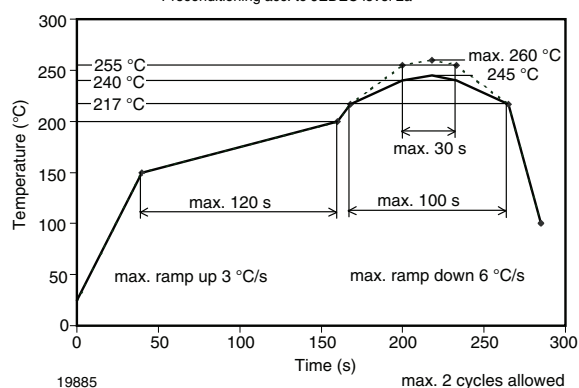


Fig. 11 - Vishay Lead (Pb)-free Reflow Soldering Profile (acc. to J-STD-020C)

TTW Soldering (acc. to CECC00802)

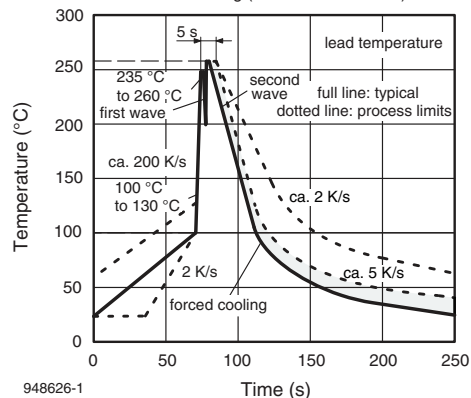


Fig. 12 - Double wave soldering of opto devices (all packages)

**BAR CODE PRODUCT LABEL (example)**


A. Type of component

B. Manufacturing plant

C. SEL - selection code (bin):

e.g.: J1 = code for luminous intensity group  
3 = code for color group

D. Date code year/week

E. Day code (e.g. 1: Monday)

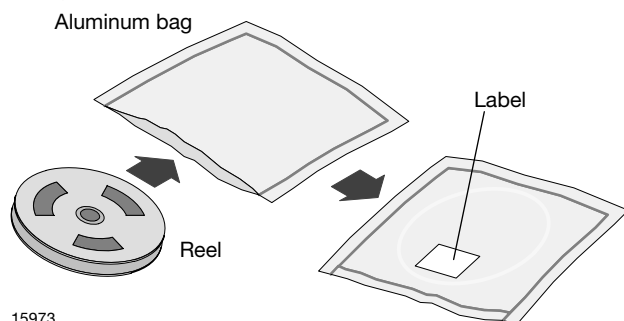
F. Batch no.

G. Total quantity

H. Company code

**DRY PACKING**

The reel is packed in an anti-humidity bag to protect the devices from absorbing moisture during transportation and storage.


**FINAL PACKING**

The sealed reel is packed into a cardboard box. A secondary cardboard box is used for shipping purposes.

**RECOMMENDED METHOD OF STORAGE**

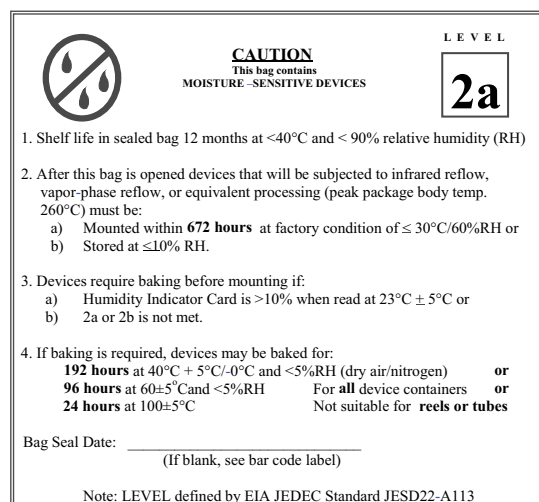
Dry box storage is recommended as soon as the aluminum bag has been opened to prevent moisture absorption. The following conditions should be observed, if dry boxes are not available:

- Storage temperature 10 °C to 30 °C
- Storage humidity ≤ 60 % RH max.

After more than 672 h under these conditions moisture content will be too high for reflow soldering.

In case of moisture absorption, the devices will recover to the former condition by drying under the following condition:  
192 h at 40 °C + 5 °C / - 0 °C and < 5 % RH (dry air/nitrogen) or  
96 h at 60 °C + 5 °C and < 5 % RH for all device containers or  
24 h at 100 °C + 5 °C not suitable for reel or tubes.

An EIA JEDEC® standard JESD22-A112 level 2a label is included on all dry bags.



Example of JESD22-A112 level 2a label

**ESD PRECAUTION**

Proper storage and handling procedures should be followed to prevent ESD damage to the devices especially when they are removed from the Antistatic Shielding Bag. Electro-Static Sensitive Devices warning labels are on the packaging.

**VISHAY SEMICONDUCTORS STANDARD BAR CODE LABELS**

The Vishay Semiconductors standard bar code labels are printed at final packing areas. The labels are on each packing unit and contain Vishay Semiconductors specific data.



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